

1822765

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PCB terminal block, nominal current: 17.5 A, rated voltage (III/2): 160 V, nominal cross section: 1.5 mm², number of potentials: 3, number of rows: 1, number of positions per row: 3, product range: SPT 1,5/..-H-THR, pitch: 3.5 mm, connection method: Push-in spring connection, mounting: THR soldering, conductor/PCB connection direction: 0 °, color: black, Pin layout: Linear pinning, Solder pin [P]: 2.6 mm, number of solder pins per potential: 2, type of packaging: packed in cardboard

Your advantages

- · Time saving push-in connection, tools not required
- Defined contact force ensures that contact remains stable over the long term
- · Intuitive operation due to color-coded actuating push button
- · Designed for integration into the SMT soldering process
- · Quick and convenient testing using integrated test option
- Operation and conductor connection from one direction enable integration into front of device
- Two solder pins reduce the mechanical strain on the soldering spots

Commercial data

Item number	1822765
Packing unit	240 pc
Minimum order quantity	240 pc
Note	Made to order (non-returnable)
Sales key	AA12
Product key	AALCCA
Catalog page	Page 10 (NTK-2014)
GTIN	4046356809580
Weight per piece (including packing)	1.76 g
Weight per piece (excluding packing)	1.726 g
Customs tariff number	85369010
Country of origin	PL



1822765

https://www.phoenixcontact.com/us/products/1822765

Technical data

Product properties

Product type	Printed circuit board terminal
Product family	SPT 1,5/H-THR
Product line	COMBICON Terminals S
Number of positions	3
Pitch	3.5 mm
Number of connections	3
Number of rows	1
Number of potentials	3
Pin layout	Linear pinning
Solder pins per potential	2

Electrical properties

Nominal current I _N	17.5 A
Nominal voltage U _N	160 V
Degree of pollution	3
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

Connection data

Connection technology

Nominal cross section	1.5 mm²
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Conductor connection

Connection method	Push-in spring connection
Conductor cross section rigid	0.2 mm ² 1.5 mm ²
Conductor cross section flexible	0.2 mm ² 1.5 mm ²
Conductor cross section AWG	24 16
Conductor cross section flexible, with ferrule without plastic sleeve	0.2 mm² 1.5 mm²
Conductor cross section, flexible, with ferrule, with plastic sleeve	0.2 mm² 0.75 mm²
Stripping length	8 mm

Mounting

Mounting type	THR soldering
Pin layout	Linear pinning
Processing notes	



1822765

https://www.phoenixcontact.com/us/products/1822765

Process	Reflow/wave soldering
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (4 - 8 μm Sn)
Metal surface soldering area (top layer)	Tin (4 - 8 μm Sn)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	Illa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Material data - actuating element

-	
Color (Actuating element)	white (9010)
Insulating material	PA GF
Insulating material group	1
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0

Notes

Assembly instruction:	This item is not suitable for PCB cleaning with liquids.
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Dimensions

Dimensional drawing	h h
Pitch	3.5 mm
Width [w]	11 mm
Height [h]	10.3 mm
Length [I]	13.6 mm
Installed height	7.7 mm
Solder pin length [P]	2.6 mm
Pin dimensions	0.7 x 0.3 mm



1822765

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PCB	design
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Pin spacing	7 mm
Hole diameter	1.1 mm

Mechanical tests

Connection test

Specification	IEC 60998-2-2:2002-12
Result	Test passed

Test for conductor damage and slackening

Specification	IEC 60998-2-2:2002-12
Result	Test passed

Pull-out test

Specification	IEC 60998-2-2:2002-12
Conductor cross section/conductor type/tractive force setpoint/actual value	0.2 mm² / solid / > 10 N
	0.2 mm² / flexible / > 10 N
	1.5 mm² / solid / > 40 N
	1.5 mm² / flexible / > 40 N

Flexion test

Result Test passed	

Insulation holder for crimp connections

institution notice for entity connections	
Result	Test passed

Electrical tests

Temperature-rise test

Specification	IEC 60947-7-4:2019-01
Requirement temperature-rise test	The sum of ambient temperature and temperature rise of the PCB terminal block shall not exceed the upper limiting temperature.

Insulation resistance

Specification	IEC 60998-1:2002-12
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

All clearances and creepage distances	
Specification	IEC 60947-7-4:2013-08
Insulating material group	Illa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm



1822765

https://www.phoenixcontact.com/us/products/1822765

Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	3.2 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz 60.1 Hz)
Sweep speed	5g (60.1 Hz 150 Hz)
Test duration per axis	2.5 h

Glow-wire test

Specification	IEC 60998-1:2002-12
Temperature	850 °C
Time of exposure	5 s

Ambient conditions

Ambient temperature (operation)	-40 °C 105 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C

Packaging specifications

Type of packaging	packed in cardboard
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